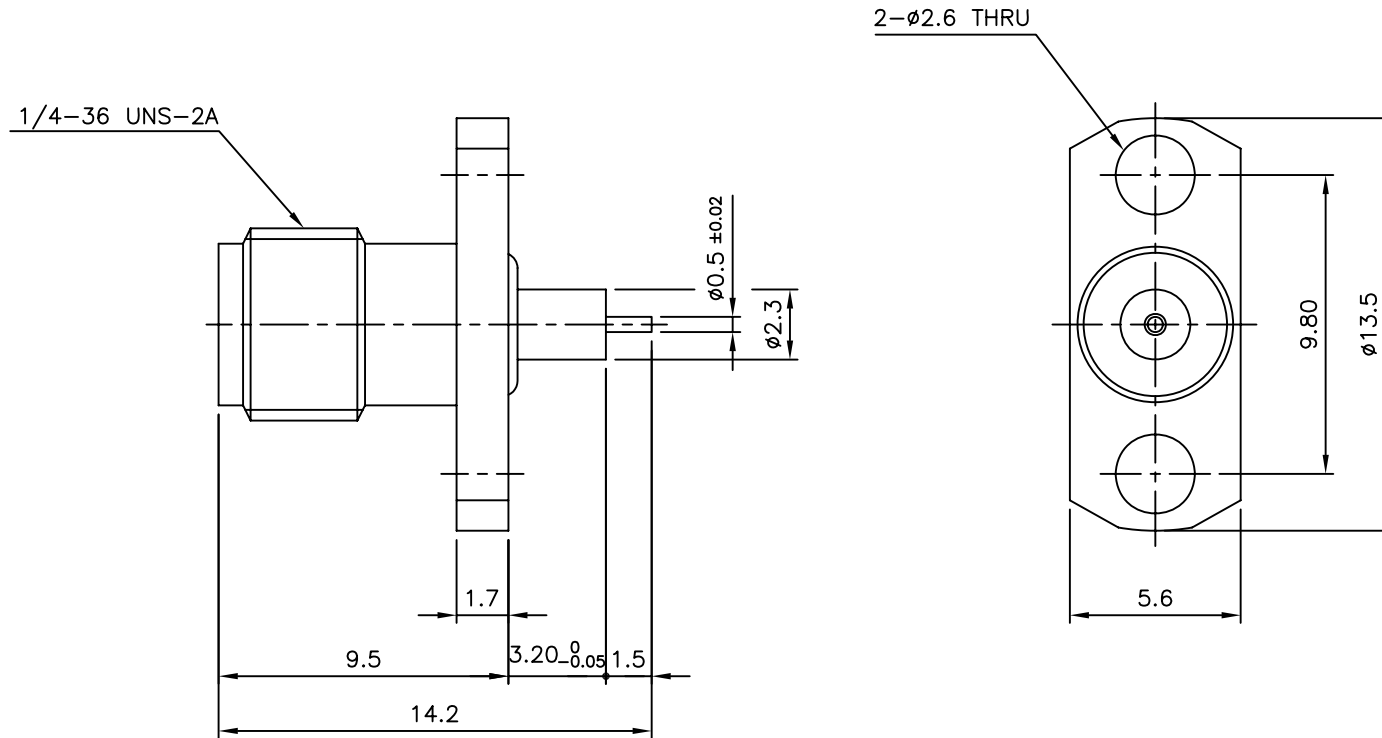


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2013.12.05.



4	INSULATOR	1	TEFLON		DIN02293-N/1
3	GASKET	1	SILICONE RUB		DGK00243-N/1
2	CONTACT	1	BeCu	Gold Plate (1.27μm)	DCT03001-5/1
1	BODY	1	SUS303	부동태 처리	DBD03507-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 12. 05.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.H.KIM	KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-2H
		DRAWN BY	I.C.KIM	
FINISH		SCALE	UNIT	A4 DWG NO. CN03130-7/1 REVISION I R SHEET 1 of 1
		4/1	mm	